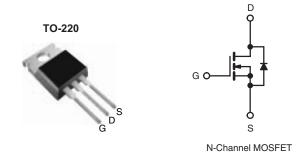


COMPLIANT



Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	100			
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = 10 V	0.16		
Q _g (Max.) (nC)	26			
Q _{gs} (nC)	5.5			
Q _{gd} (nC)	11			
Configuration	Single			



FEATURES

- Dynamic dV/dt Rating
- · Repetitive Avalanche Rated
- 175 °C Operating Temperature
- · Fast Switching
- · Ease of Paralleling
- · Simple Drive Requirements
- Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220		
Lead (Pb)-free	IRF530PbF		
	SiHF530-E3		
SnPb	IRF530		
	SiHF530		

ABSOLUTE MAXIMUM RATINGS T	_C = 25 °C, unless otherw	ise noted			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V_{DS}	100		
Gate-Source Voltage	V_{GS}	± 20	V		
Continuous Drain Current	V_{GS} at 10 V $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 100 ^{\circ}\text{C}$	I _D	14		
	V_{GS} at 10 V $T_{C} = 100 ^{\circ}$ C		10	Α	
Pulsed Drain Current ^a	I _{DM}	56			
Linear Derating Factor			0.59	W/°C	
Single Pulse Avalanche Energy ^b	E _{AS}	69	mJ		
Repetitive Avalanche Current ^a	I _{AR}	14	Α		
Repetitive Avalanche Energy ^a	E _{AR}	8.8	mJ		
Maximum Power Dissipation	T _C = 25 °C	P_{D}	88	W	
Peak Diode Recovery dV/dtc	dV/dt	5.5	V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	- °C	
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d		
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in	
	0-32 OF IVIS SCIEW		1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 528 μ H, R_G = 25 Ω , I_{AS} = 14 A (see fig. 12).
- c. $I_{SD} \le 14$ A, $dI/dt \le 140$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.7	

PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static						l	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0	100	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 1 mA		0.12	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		-	4.0	V
Gate-Source Leakage	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
Zero Gate Voltage Drain Current	1	V _{DS} = 100 V, V _{GS} = 0 V		-	-	25	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V, V	V _{DS} = 80 V, V _{GS} = 0 V, T _J = 150 °C		-	250	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 8.4 A ^b	-	-	0.16	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = 5$	V _{DS} = 50 V, I _D = 8.4 A ^b		-	-	S
Dynamic					-		
Input Capacitance	C_{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		i	670	-	
Output Capacitance	C _{oss}			-	250	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0	f = 1.0 MHz, see fig. 5		60	-	
Total Gate Charge	Q_g			-	-	26	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 14 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 ^b	-	-	5.5	nC
Gate-Drain Charge	Q_{gd}			-	-	11	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 50 \text{ V, } I_D = 14 \text{ A}$ $R_G = 12 \Omega, \ R_D = 3.6 \Omega, \ \text{see fig. } 10^b$		-	10	-	ns
Rise Time	t _r			-	34	-	
Turn-Off Delay Time	t _{d(off)}			-	23	-	
Fall Time	t _f			-	24	-	
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	- nH
Internal Source Inductance	L _S			-	7.5	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	showing the	MOSFET symbol showing the		-	14	- A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		ı	-	56	
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S = 14 A, V _{GS} = 0 V ^b		-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 14 A, dl/dt = 100 A/μs ^b		-	150	280	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.85	1.7	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_{Γ}				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

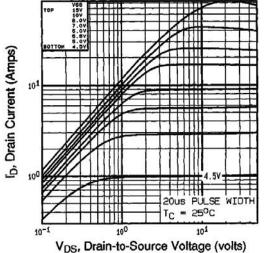


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

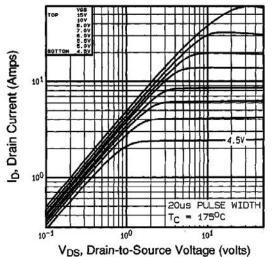


Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C

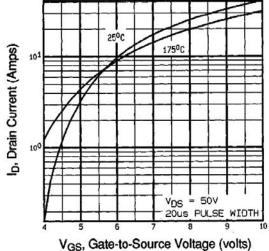


Fig. 3 - Typical Transfer Characteristics

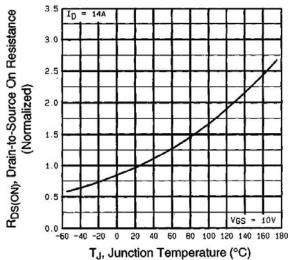


Fig. 4 - Normalized On-Resistance vs. Temperature

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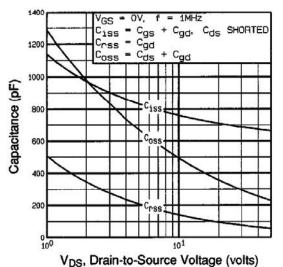
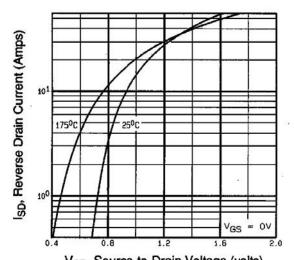


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



V_{SD}, Source-to-Drain Voltage (volts)
Fig. 7 - Typical Source-Drain Diode Forward Voltage

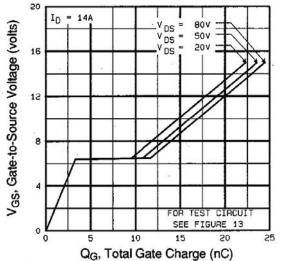


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

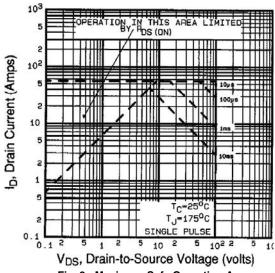


Fig. 8 - Maximum Safe Operating Area



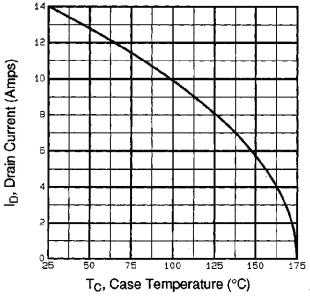


Fig. 9 - Maximum Drain Current vs. Case Temperature

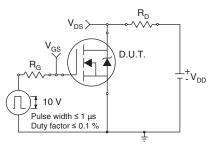


Fig. 10a - Switching Time Test Circuit

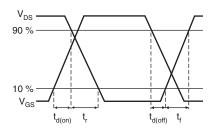


Fig. 10b - Switching Time Waveforms

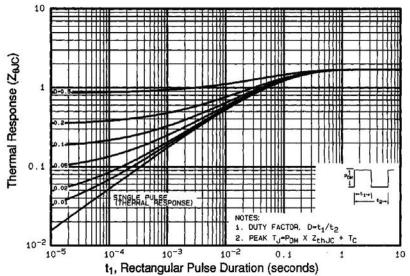


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

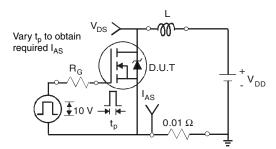


Fig. 12a - Unclamped Inductive Test Circuit

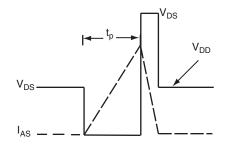
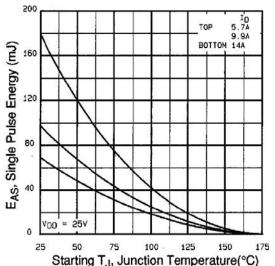


Fig. 12b - Unclamped Inductive Waveforms

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Starting T_J, Junction Temperature(°C)
Fig. 12c - Maximum Avalanche Energy vs. Drain Current

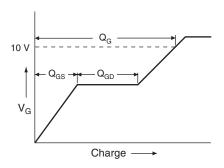


Fig. 13a - Basic Gate Charge Waveform

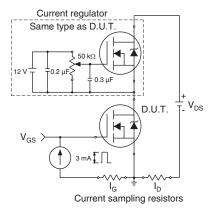
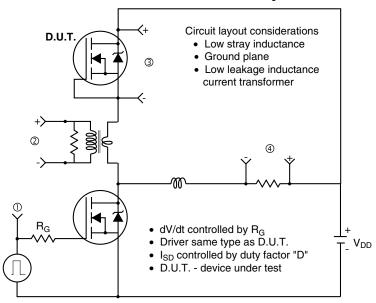
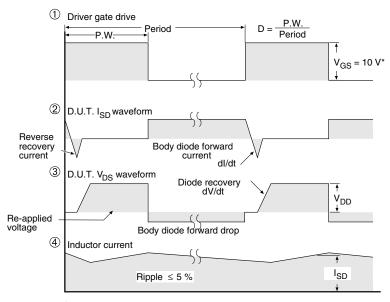


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit





* $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com